

# Design of 200W LLC Resonant HB

Sober Hu (胡炎申)

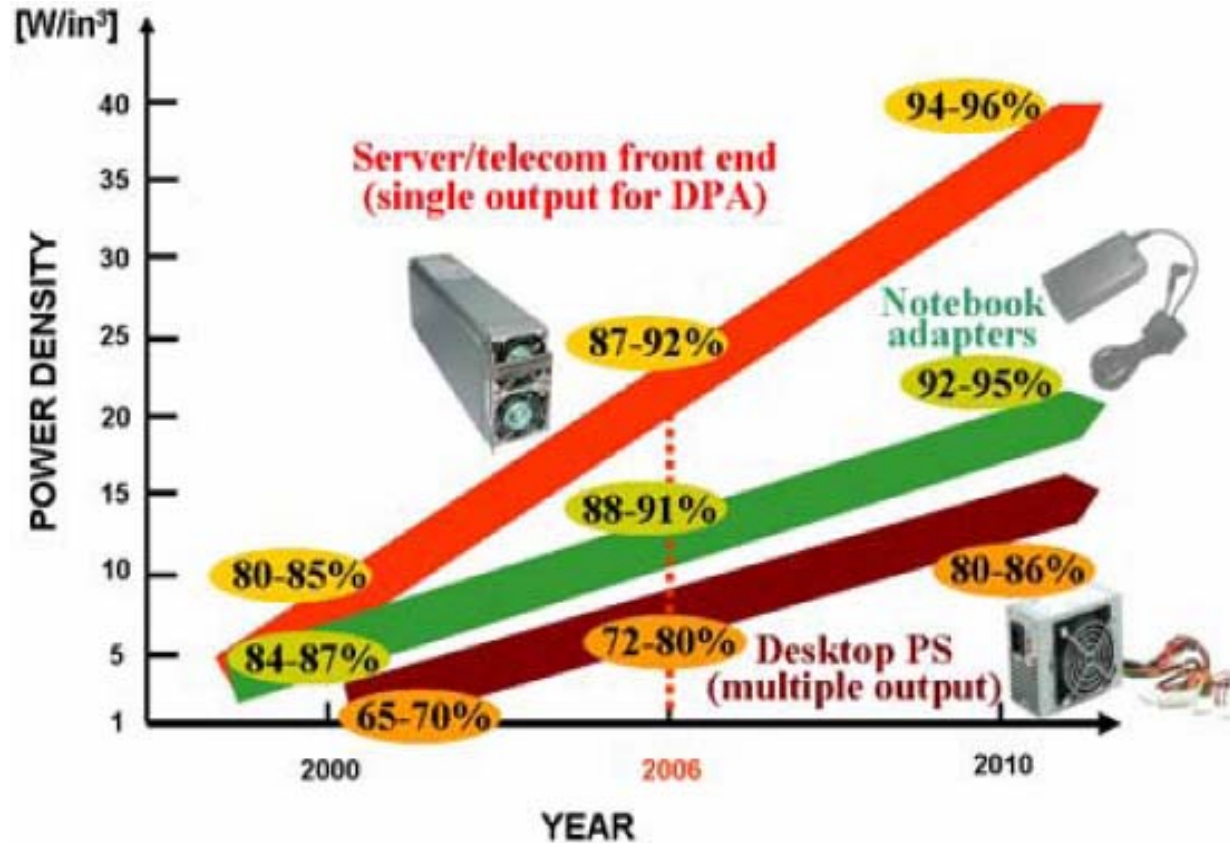
世纪电源网-版主 (斜阳古道)

Texas Instruments Semiconductor

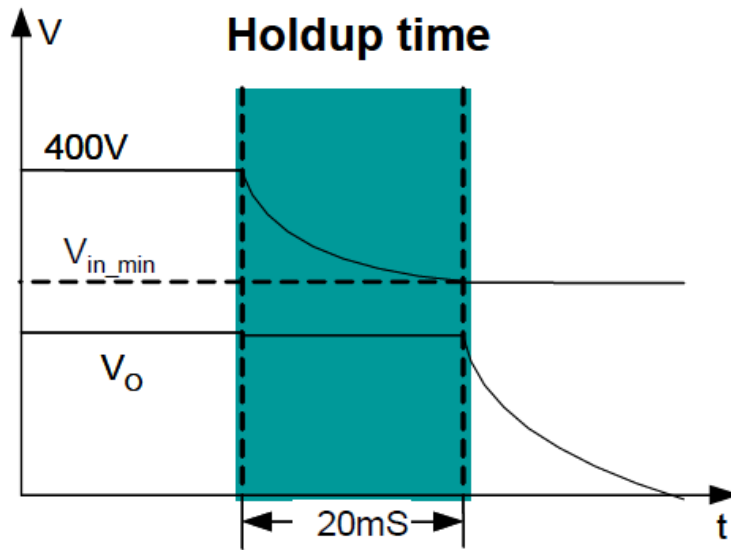
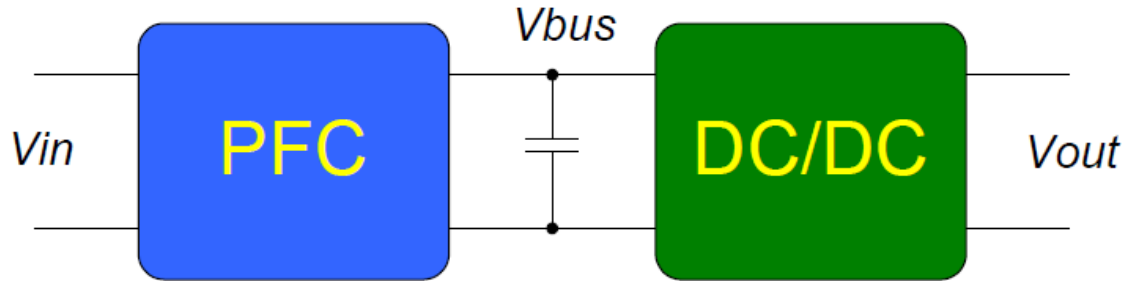
Dec 2009

# Technical Challenges of Front-End AC/DC Converter

# Efficiency and Power Density

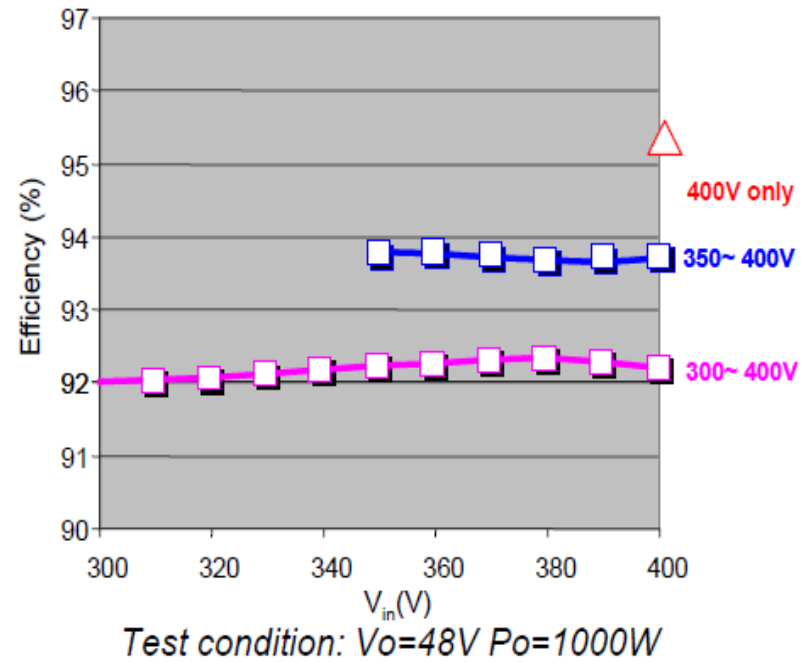
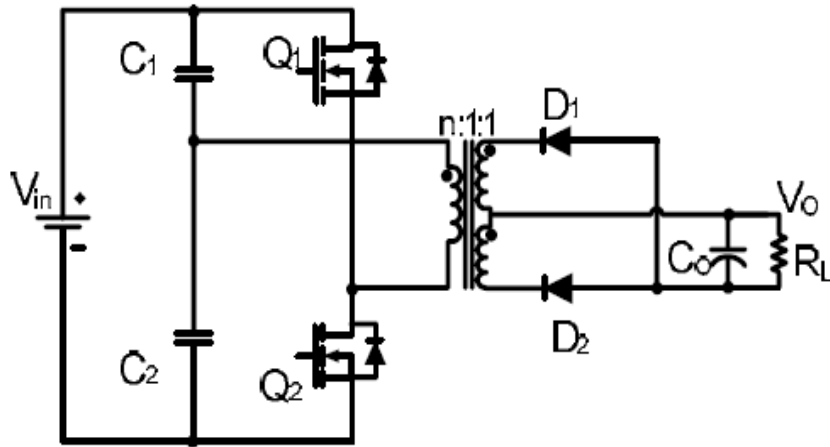


# Hold-Up Time



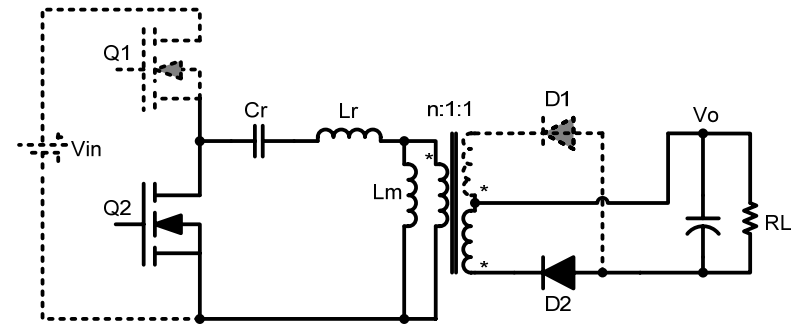
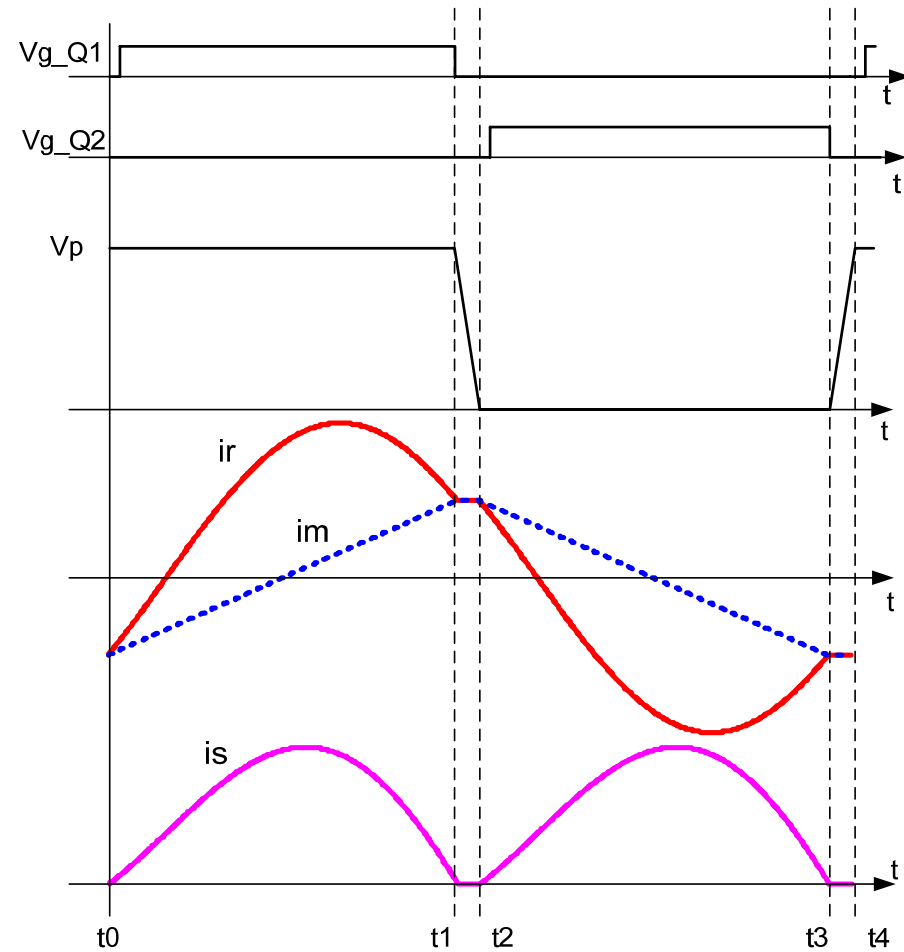
$$\frac{1}{2} C_h (V_{in}^2 - V_{in\_min}^2) = P_{DC} T_h$$

# Limitation of PWM Converter



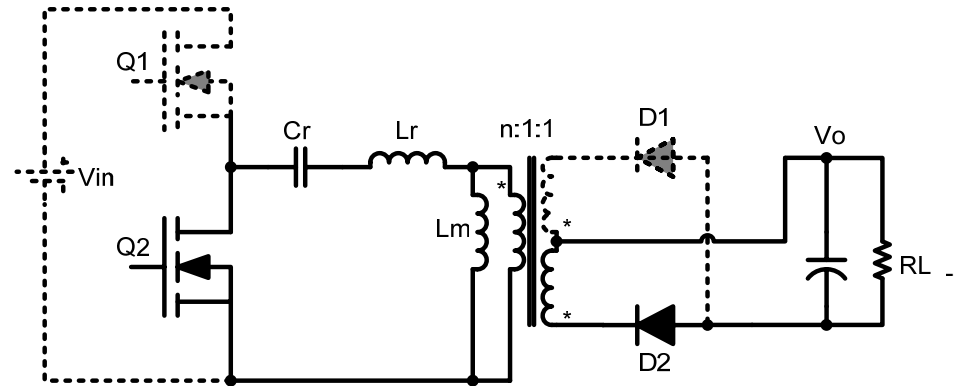
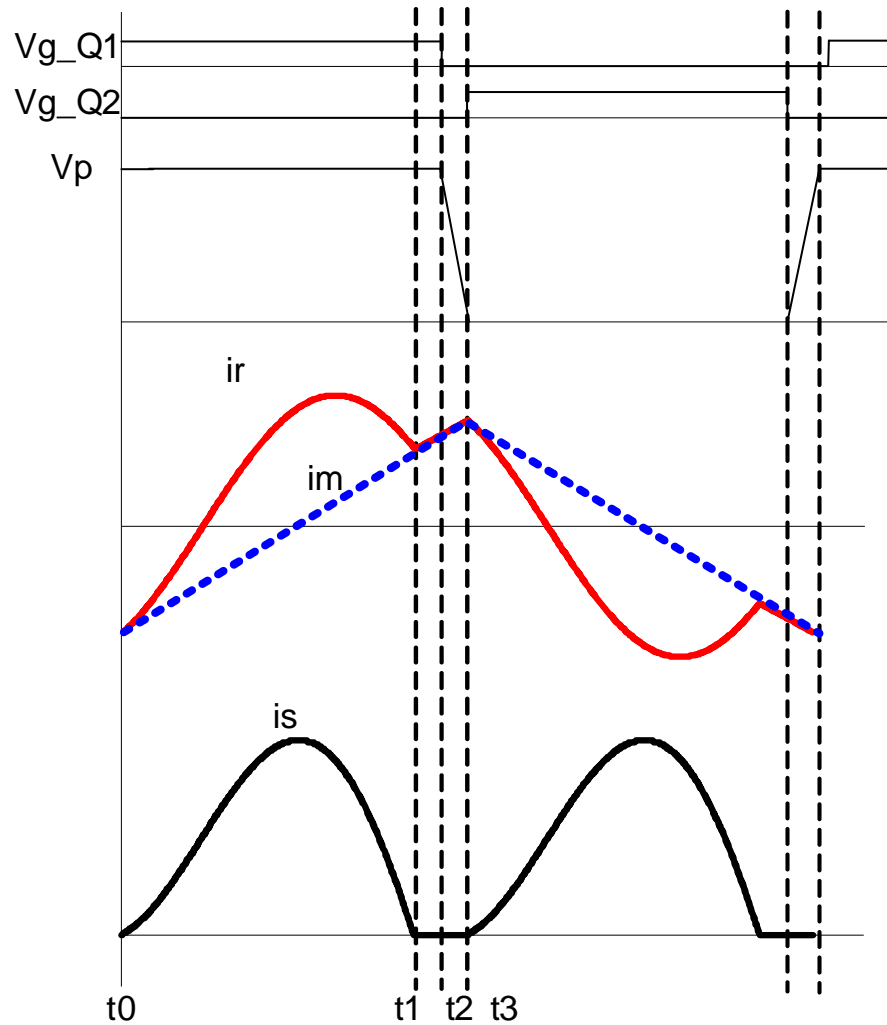
# Operation of LLC Resonant HB

# Operation Principles ( $f_{sw}=f_r$ )



➤ At resonant frequency, maximum efficiency is expected

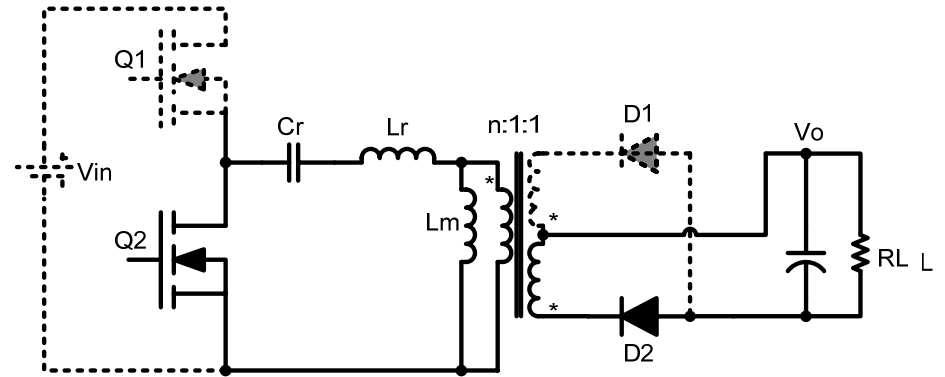
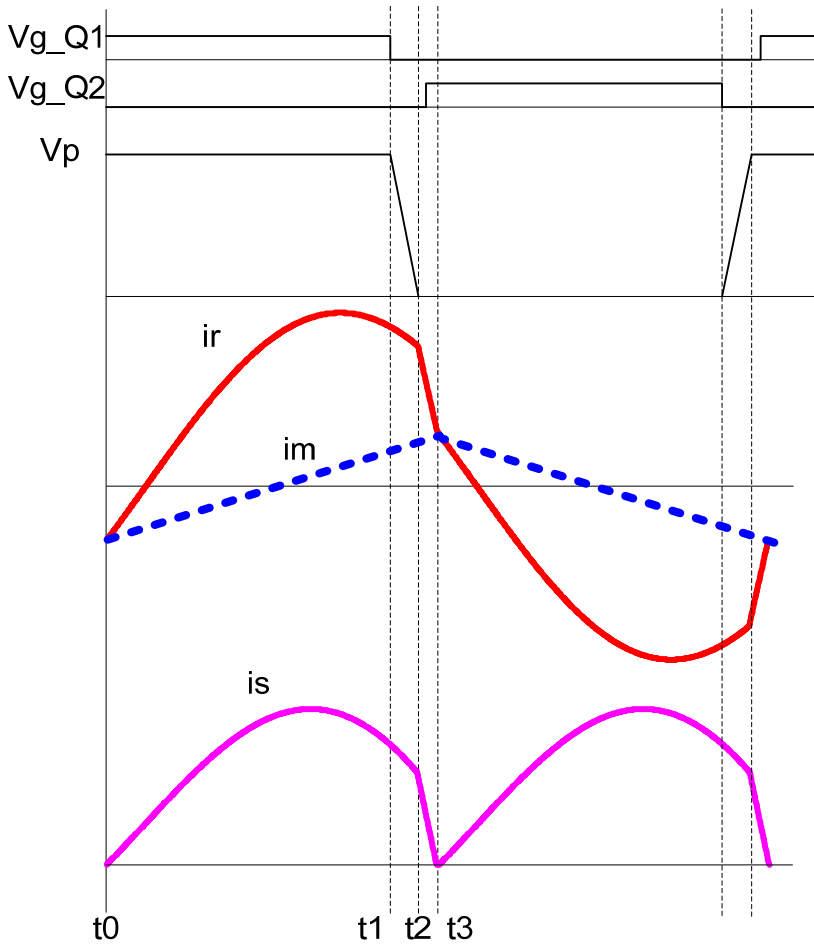
# Operation Principles ( $f_{sw} < f_r$ )



- When switching frequency is below resonant frequency, magnetizing inductor begins to participate in resonant and increase voltage gain
- Secondary diode becomes discontinuous

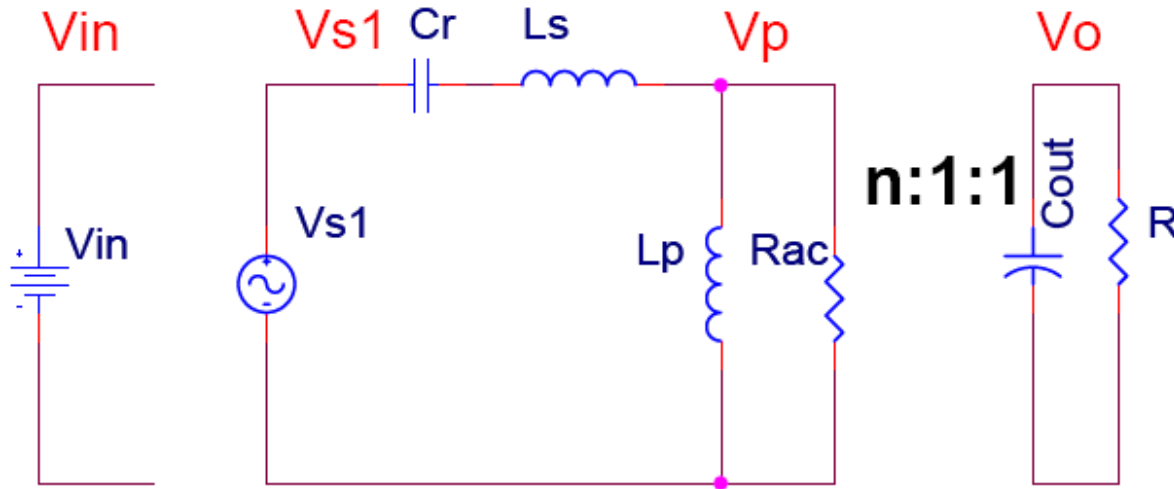


# Operation Principles ( $f_{sw} > f_r$ )



- When switching frequency is above resonant frequency, circuit behaves as SRC
- Secondary current becomes CCM, reverse recovery loss increases

# FHA of LLC Resonant HB



$$V_{s1} = \frac{2}{\pi} V_{in} \Rightarrow V_{in} = \frac{\pi}{2} V_{s1}$$

$$V_p = n V_{r1} = n \frac{4}{\pi} V_o \Rightarrow V_o = \frac{\pi}{4n} V_p$$

$$|G| = \frac{n V_o}{\frac{V_{in}}{2}} = \frac{n \frac{\pi}{4n} V_p}{\frac{\pi}{4} V_{s1}} = \frac{V_p}{V_{s1}}$$

$$= \frac{sL_p // R_{ac}}{1/sC_r + sL_r + (sL_p // R_{ac})}$$

# Voltage Gain Equation

$$M(f_n, L_n, Q) = \frac{nV_o}{V_{in}} = \frac{n \frac{\pi}{4n} V_{Ro}^F}{\frac{\pi}{4} V_d^F} = \frac{V_{Ro}^F}{V_d^F}$$

$$L_n = \frac{L_m}{L_r}$$

$$f_n = \frac{f_{sw}}{f_r}$$

$$Q = \sqrt{\frac{L_r}{C_r}} \cdot \frac{1}{R_{ac}}$$

$$R_{ac} = \frac{8n^2}{\pi^2} \cdot \frac{V_{out}}{I_{out}}$$

$$f_r = \frac{1}{2\pi\sqrt{L_r C_r}}$$

$$f_p = \frac{1}{2\pi\sqrt{(L_m + L_r)C_r}}$$

$$= \left| \frac{(j\omega L_m) // R_{ac}}{\frac{1}{j\omega C_r} + j\omega L_r + (j\omega L_m) // R_{ac}} \right|$$

$$= \left| \frac{\frac{(j\omega L_m) R_{ac}}{(j\omega L_m) + R_{ac}}}{\frac{1}{j\omega C_r} + j\omega L_r + \frac{(j\omega L_m) R_{ac}}{(j\omega L_m) + R_{ac}}} \right|$$

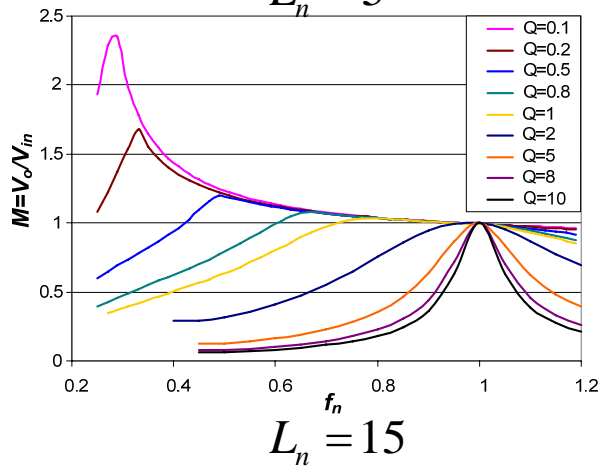
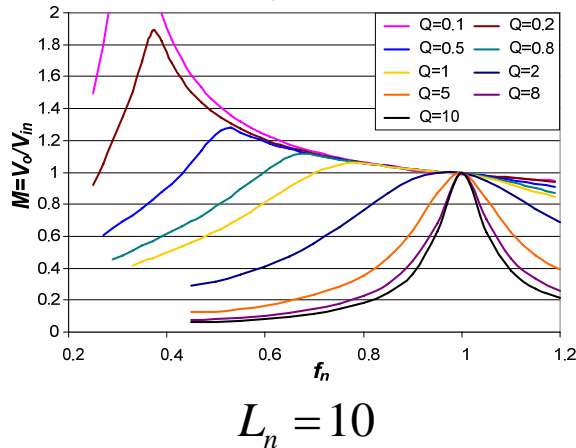
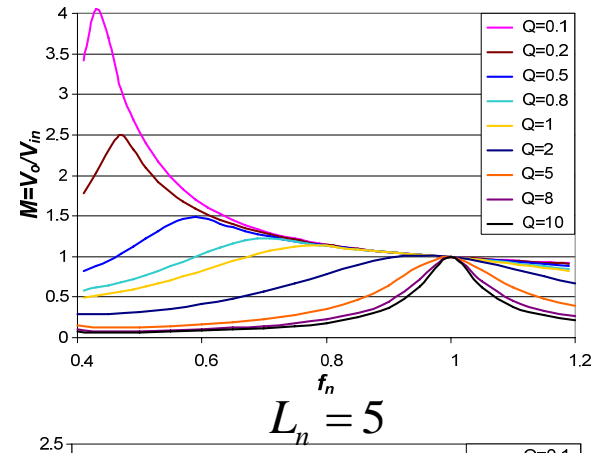
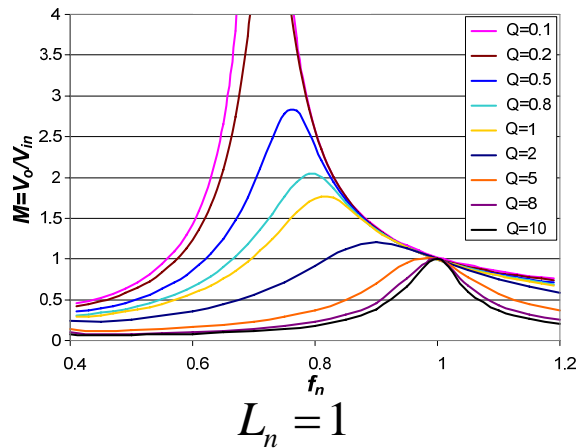
$$= \left| \frac{j\omega L_m R_{ac}}{\frac{L_m}{C_r} - \omega^2 L_m L_r + R_{ac} \left( \frac{1 - \omega^2 L_r C_r}{j\omega C_r} \right) + j\omega L_m R_{ac}} \right|$$

$$= \left| \frac{\omega^2 L_m C_r R_{ac}}{[\omega^2 (L_m + L_r) C_r - 1] R_{ac} + j\omega \cdot L_m \cdot (\omega^2 L_r C_r - 1)} \right|$$

$$= \left| \frac{\left( \frac{\omega}{\omega_r} \right)^2 \cdot \frac{L_m}{L_r}}{\left( \frac{\omega}{\omega_r} \right)^2 \cdot \frac{L_m + L_r}{L_r} - 1 + j \frac{\omega}{\omega_r} \cdot \left[ \left( \frac{\omega}{\omega_r} \right)^2 - 1 \right] \cdot \frac{L_m}{L_r} \cdot \sqrt{\frac{L_r}{C_r}} \cdot \frac{1}{R_{ac}}} \right|$$

$$= \frac{1}{\sqrt{\left[ 1 + \frac{1}{L_n} \cdot \left( 1 - \frac{1}{f_n^2} \right) \right]^2 + Q^2 \cdot \left( f_n - \frac{1}{f_n} \right)^2}}$$

# Voltage Gain of Different $L_n$



$L_n \uparrow \rightarrow$  Traditional SRC  $\rightarrow$  Enter into ZCS @  $f_{sw} < f_r \rightarrow$  lost gain monotony and MOSFET ZVS operation  
 $\rightarrow$  much wider  $f_{sw}$  range, not good hold-up time performance

$L_n \downarrow \rightarrow$  if low inductance  $\rightarrow I_m \uparrow \rightarrow$  conducted and switched-off losses  $\uparrow$   
 $\rightarrow$  if high inductance, fixed resonant frequency  $\rightarrow C_r \downarrow \rightarrow V_{cr} \uparrow$

# Start Up Current Consideration

$$I_p^* = \begin{cases} \frac{\pi^2}{4 \cdot Q} & 1 < \Omega_s \leq 2 \\ \frac{\pi^2}{4 \cdot Q} \cdot \sin\left(\frac{\pi}{\Omega_s}\right) & \Omega_s > 2 \end{cases} \quad \Omega_s = \frac{f_{s-startup}}{f_0}$$

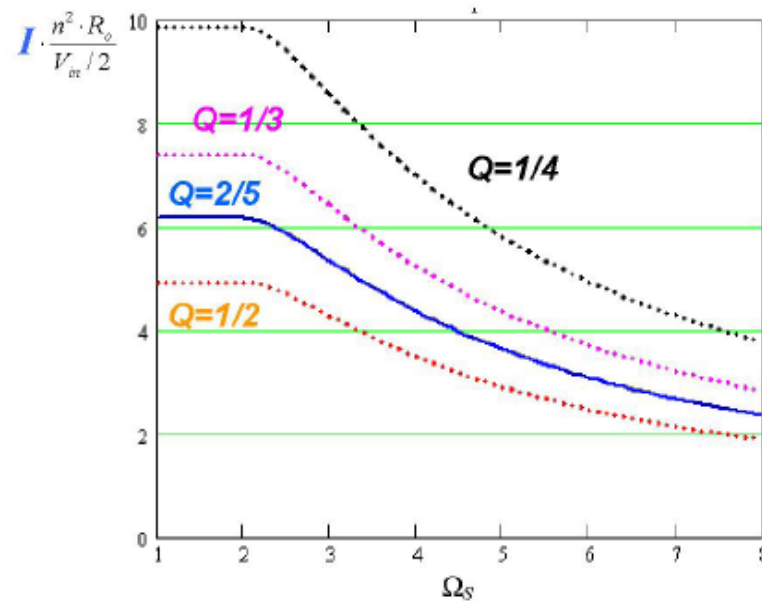


Fig.9 Normalized start-up first peak current

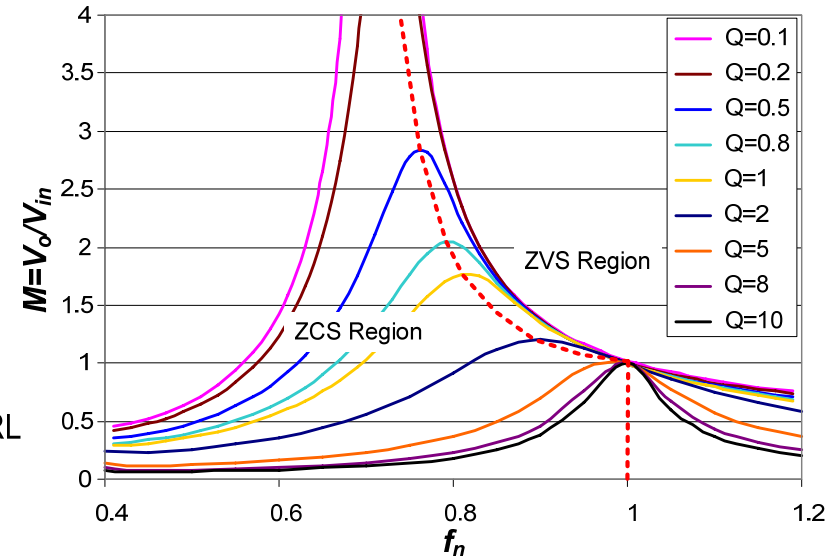
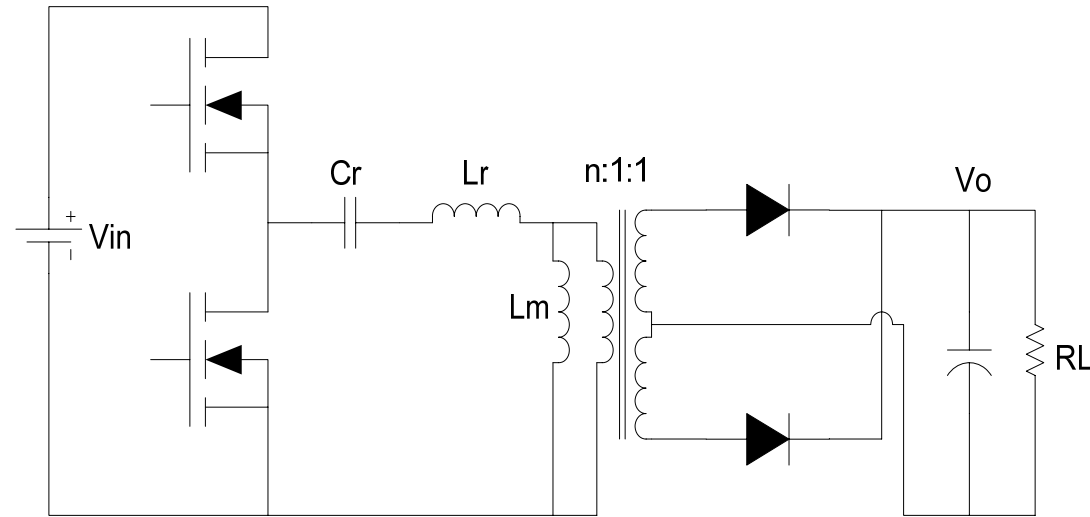
- Larger Q value gives smaller start up current with less frequency range

# Advantages of LLC Resonant HB

- Primary ZVS can be achieved with wide load range
- Secondary ZCS can be achieved when  $f_s < f_r$
- Smaller switch-off loss due to small turn off current
- Capacitor filter w/o output inductor
- Less voltage stress on rectifiers
- $>1$  voltage gain during hold-up time

# Step by Step Design of 200W LLC

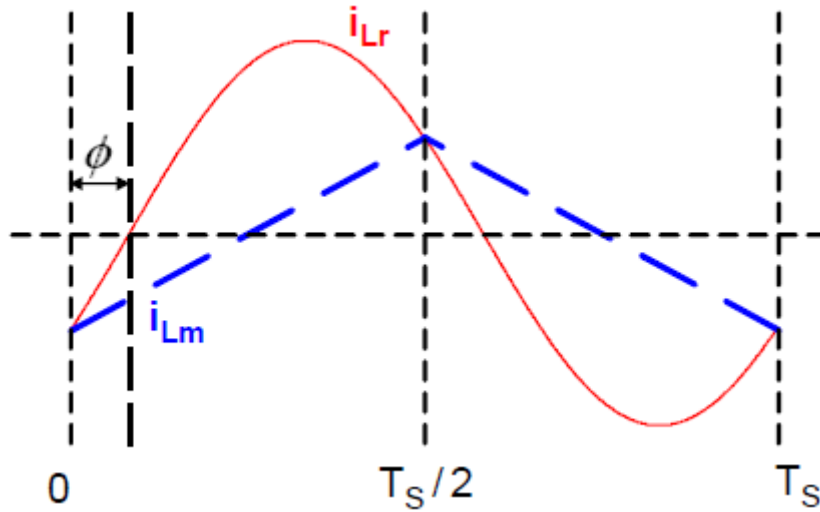
# Design Targets



- Minimize RMS current under normal operation condition
- Ensure ZVS operation
- Ensure desired input voltage operation range



# fsw=fr @ normal operation



$$i_{Lr}(t) = \sqrt{2}I_{RMS\_P} \sin(\omega_o t + \Phi)$$

$$\begin{cases} i_{Lm}(t) = -i_{Lm\_m} + \frac{nV_o}{Lm}t, t < \frac{T_s}{2} \\ i_{Lm}(t) = i_{Lm\_m} - \frac{nV_o}{Lm}(t - \frac{T_s}{2}), t > \frac{T_s}{2} \end{cases}$$

$$i_{Lr}(t_0) = \sqrt{2}I_{RMS\_P} \sin(\Phi) = -\frac{nV_o}{Lm} \cdot \frac{T_s}{4}$$

$$i_{Lm} = \frac{nV_o}{Lm} \cdot \frac{T_s}{4}$$

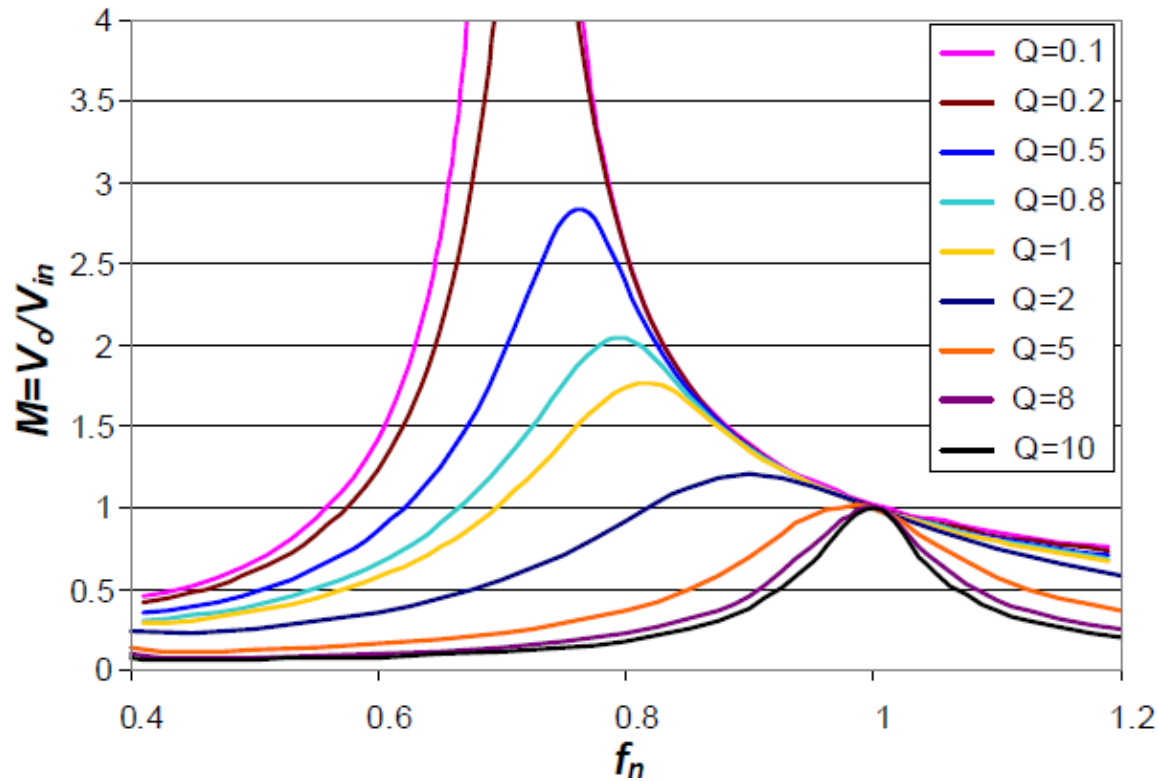
$$\frac{V_o}{nR_L} = \frac{\int_0^{T_s} [i_{Lr}(t) - i_{Lm}(t)] dt}{\frac{T_s}{2}} = \frac{\int_0^{T_s} [\sqrt{2}I_{RMS\_P} \sin(\omega_o t + \Phi) + \frac{nV_o}{Lm} \cdot \frac{T_s}{4} - \frac{nV_o}{Lm} t] dt}{\frac{T_s}{2}}$$

$$I_{RMS\_S} = \sqrt{\frac{\int_0^{T_s} [n \cdot i_{Lr}(t) - n \cdot i_{Lm}(t)]^2 dt}{\frac{T_s}{2}}}$$

$$I_{RMS\_P} = \frac{1}{4\sqrt{2}} \frac{V_o}{nR_L} \sqrt{\frac{n^4 R_L^2 T_s^2}{L_m^2} + 4\pi^2}$$

$$I_{RMS\_S} = \frac{\sqrt{3}}{24\pi} \frac{V_o}{R_L} \sqrt{\frac{(5\pi^2 - 48)n^4 R_L^2 T_s^2}{L_m^2} + 12\pi^4}$$

# $f_{sw} < f_r$ @ hold-up time



# Electrical Parameters

Nominal Vin	440V
Minimum Vin	360V
Maximum Vin	54V
Output Power	200W
Resonant Frequency	100kHz

# 1. Winding Turn Ratio of TX

fsw=fr at nominal condition, M=1, So

$$n = \frac{V_{PFC}}{2} \cdot \frac{1}{V_{out} + V_F}$$

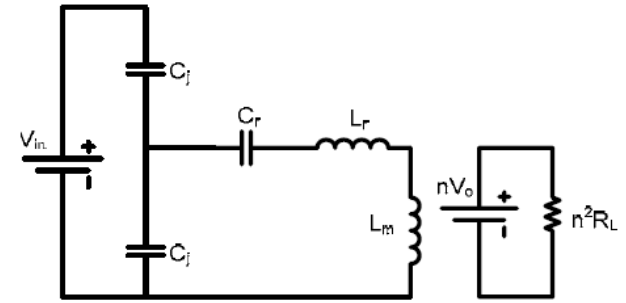
$$n=4$$

# 2. Magnetizing Inductance

The magnetizing inductance impacts conducted and switched losses, So

$$I_{RMS\_P} = \frac{1}{4\sqrt{2}} \frac{V_o}{nR_L} \sqrt{\frac{n^4 R_L^2 T_s^2}{L_m^2} + 4\pi^2}$$

$$I_{RMS\_S} = \frac{\sqrt{3}}{24\pi} \frac{V_o}{R_L} \sqrt{\frac{(5\pi^2 - 48)n^4 R_L^2 T_s^2}{L_m^2} + 12\pi^4}$$



On the other hand, the maximum magnetizing current also impacts ZVS operation.

$$\left\{ \begin{array}{l} I_{Lmp} > \frac{2V_{PFC} C_j}{td} \\ I_{Lmp} = \frac{nV_o T_s}{L_m 4} \Rightarrow L_m < \frac{T_s \cdot td}{16C_j} \\ V_{PFC} = 2nV_o \end{array} \right. \quad L_m = \frac{T_s \cdot td}{16C_j} = \frac{td}{16f_{sw} C_j}$$

$$td = 175 \text{ ns}$$

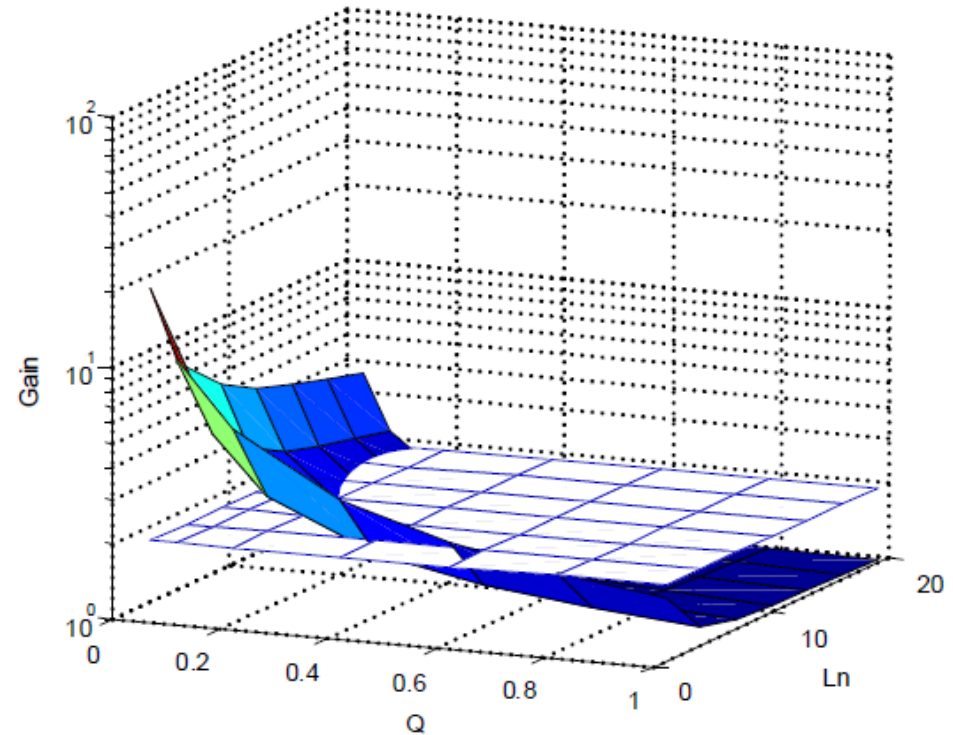
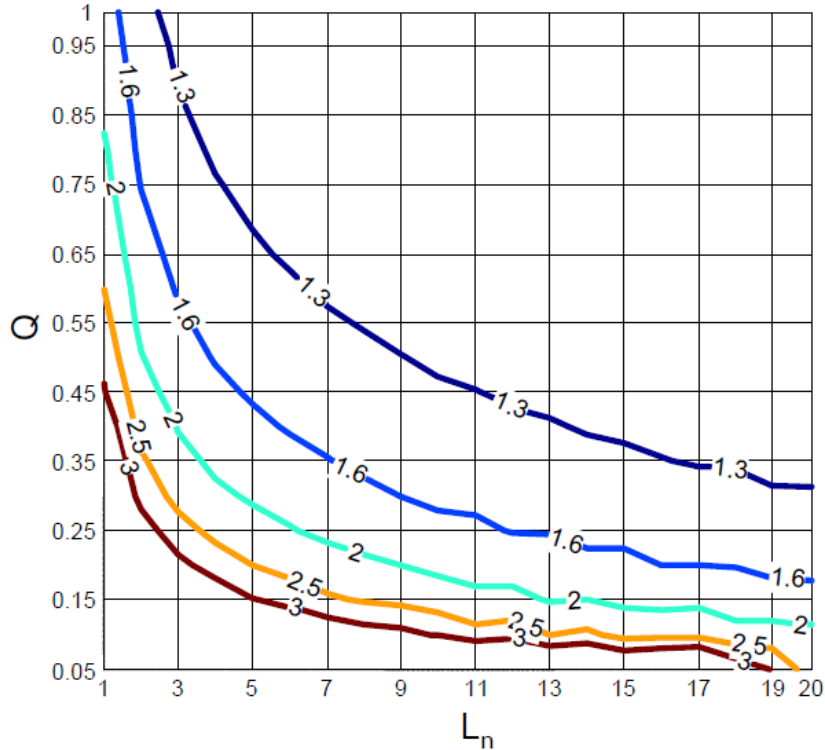
$$C_j = 195 \text{ pF, SPP20N60C3}$$

$$L_m = 530$$

# 3. Maximum Peak Gain

$$G_{\max} = \frac{V_{PFC}}{V_{\min}}$$

Gmax=1.222



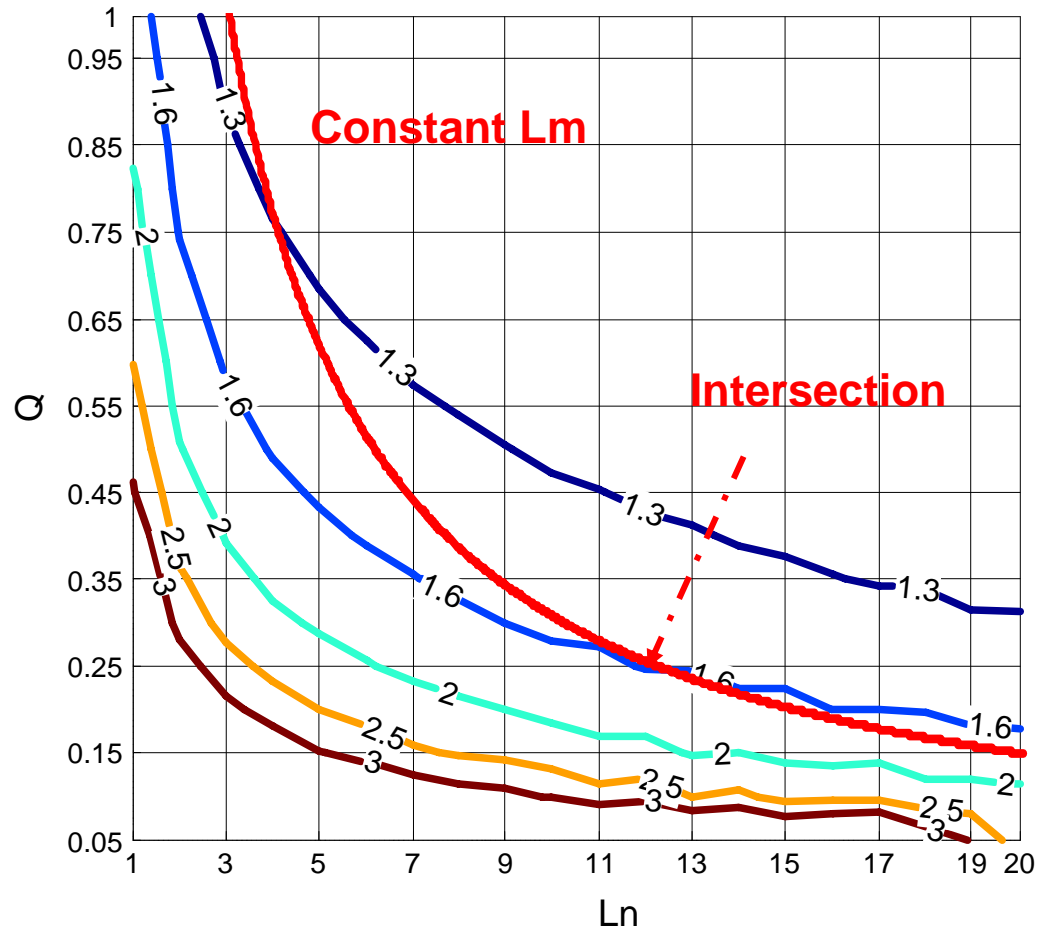
# 4. Decision Ln and Q

$$\left\{ \begin{array}{l} Q = \frac{\sqrt{Lr}}{Rac} \\ L_n = \frac{Lm}{Lr} \end{array} \right. \Rightarrow L_n Q = \frac{2\pi f_o L_m}{8n^2 \cdot R_L}$$

From the intersection of curves of LnQ and required maximum peak gain to get the appropriate Ln and Q.

Ln=6

Q=0.3



# 5. Calculation of $L_r$ and $C_r$

$$L_r = \frac{L_m}{L_n}$$

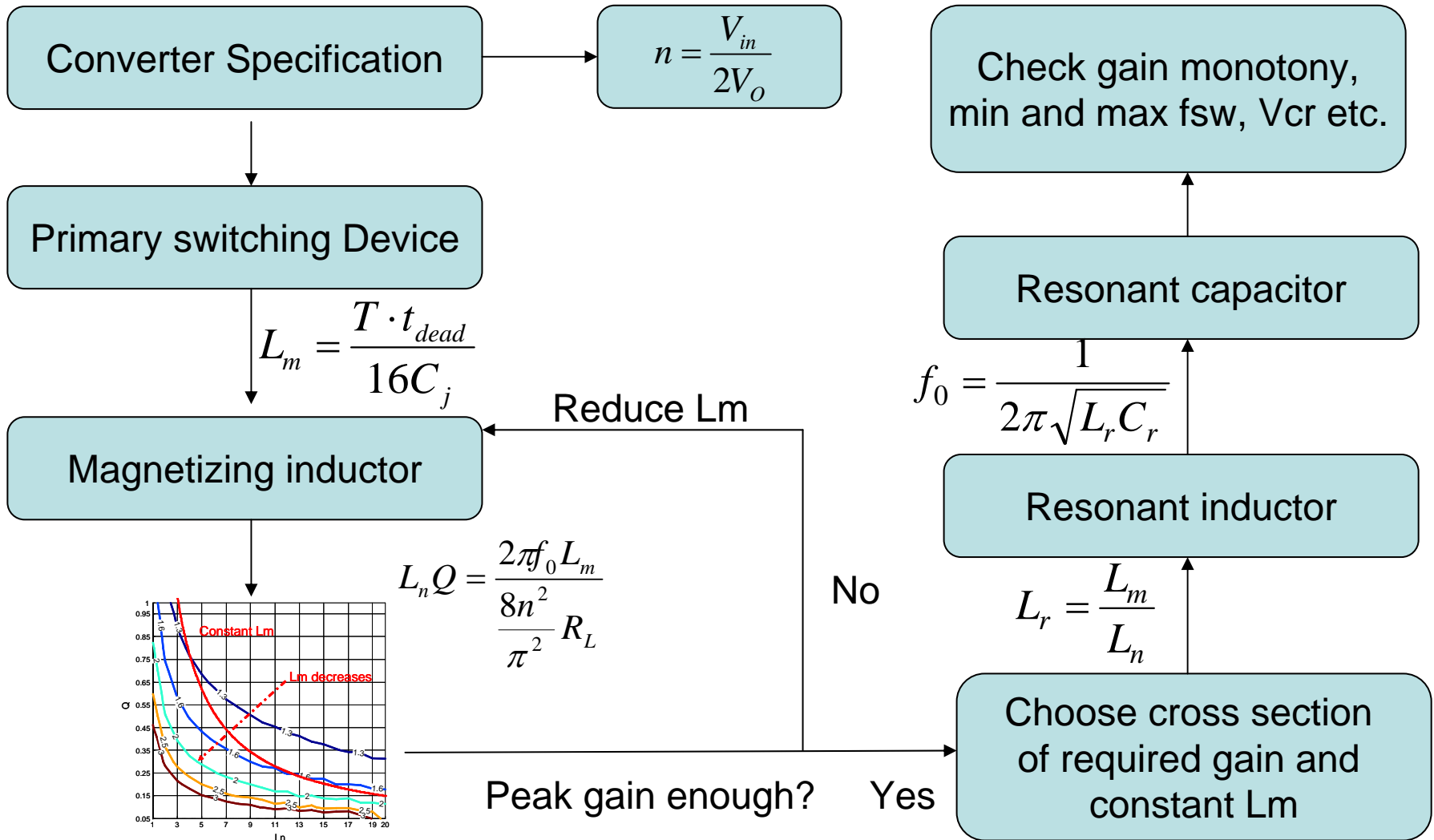
$$C_r = \frac{1}{(2\pi f_o)^2 L_r}$$

$L_r=68\mu\text{H}$ , additional  $20\mu\text{H}$  leakage inductor in main transformer

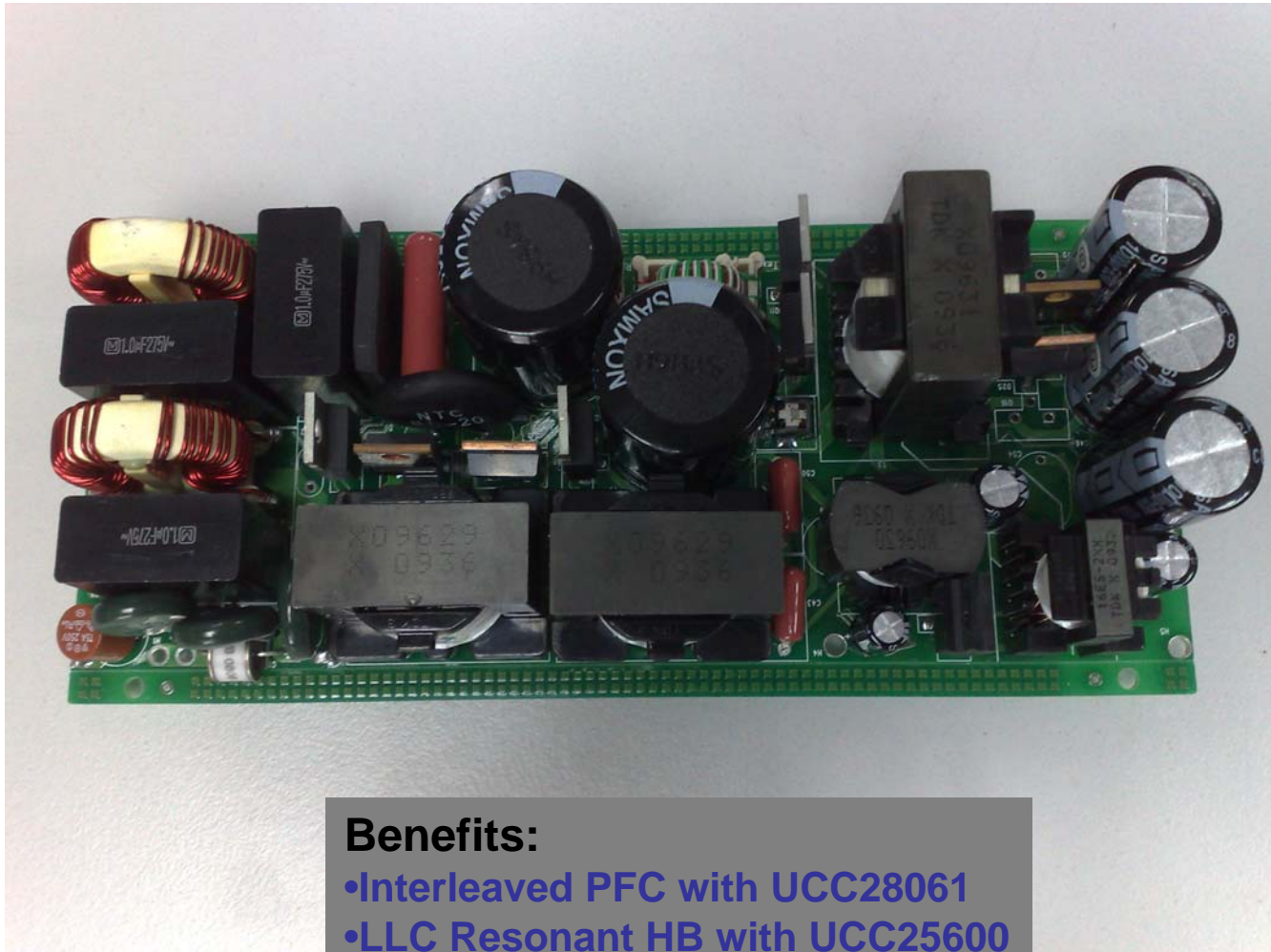
$C_r=15\text{nF} \times 2$ , two capacitor structure to reduce input ripple current



# Flow Chart of Optimal Design



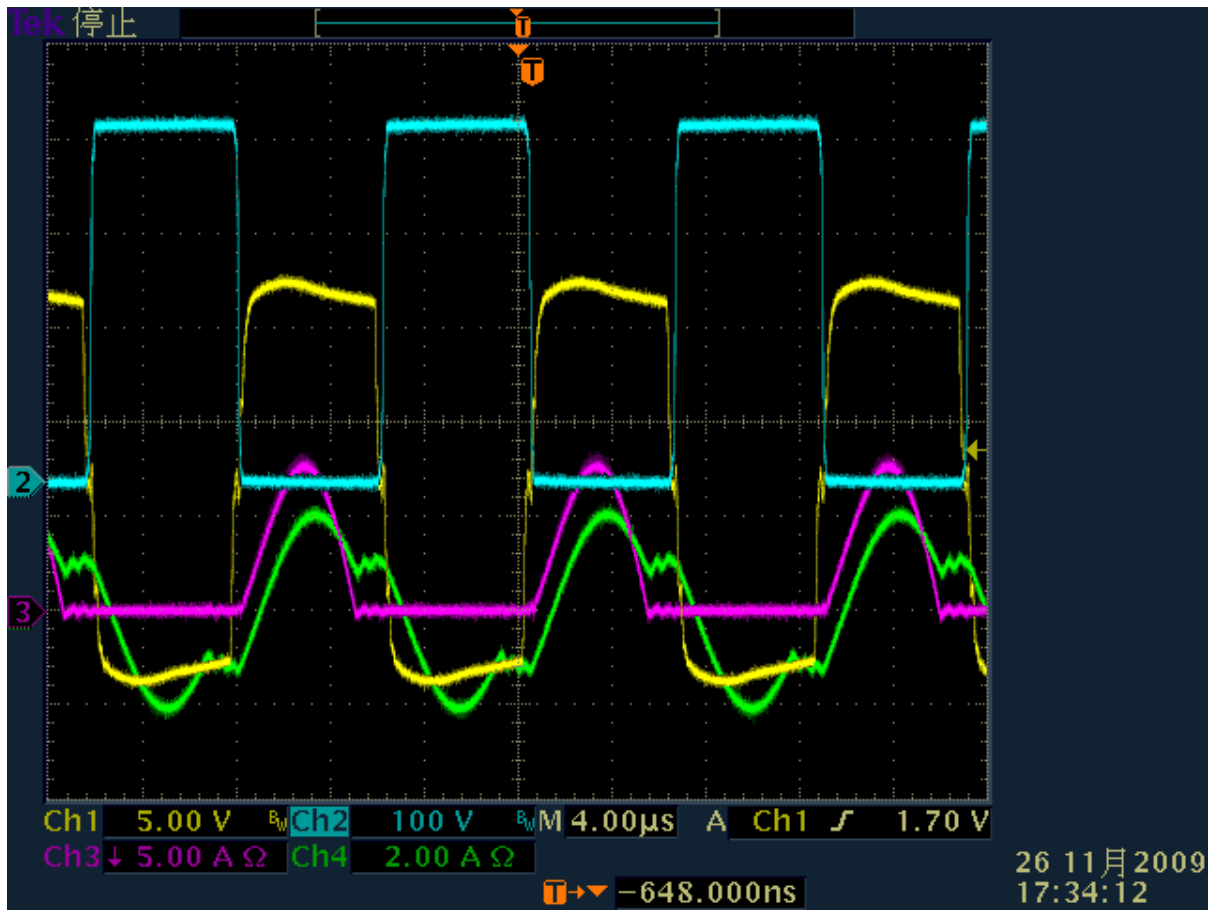
# Test of 200W LLC Resonant HB



### **Benefits:**

- Interleaved PFC with UCC28061
- LLC Resonant HB with UCC25600
- 93% Efficiency w/o Secondary SR

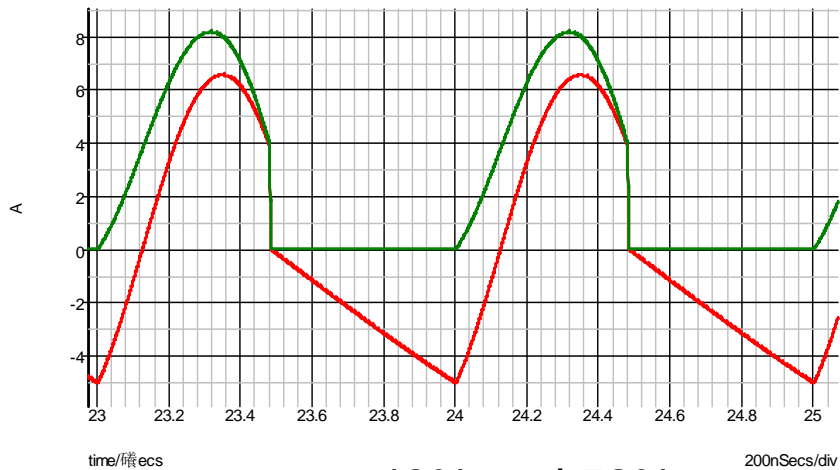




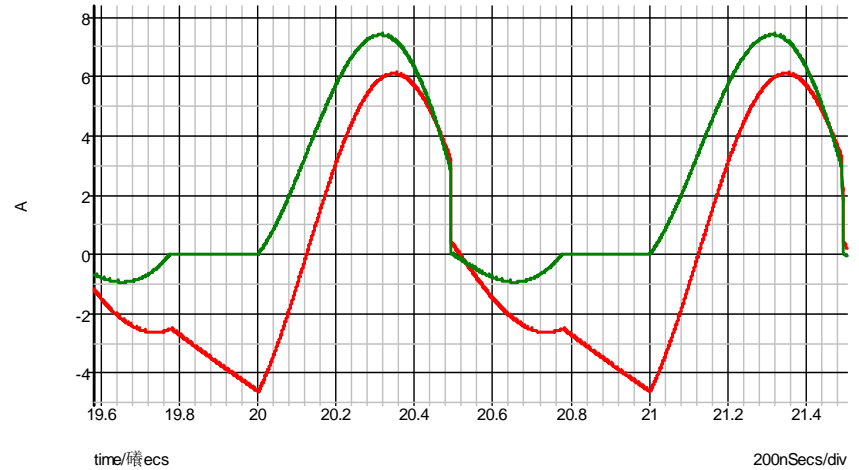
Eff=96.61%

# Possible Technical Issues

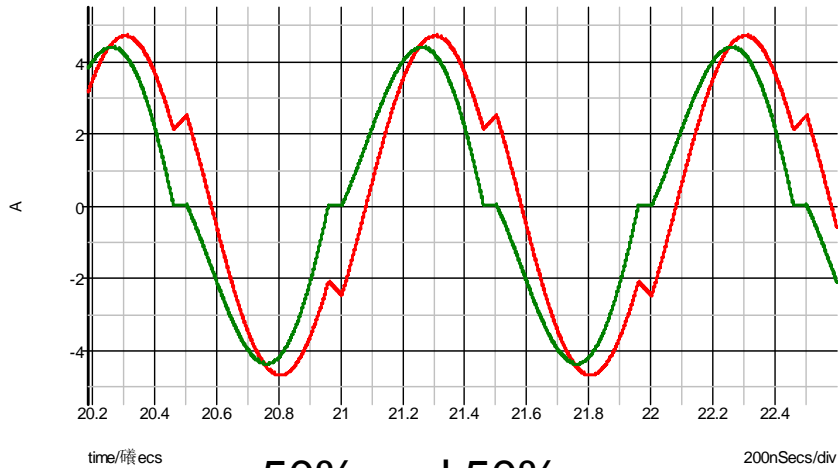
# LLC Issue-Imbalance Current



48% and 52%



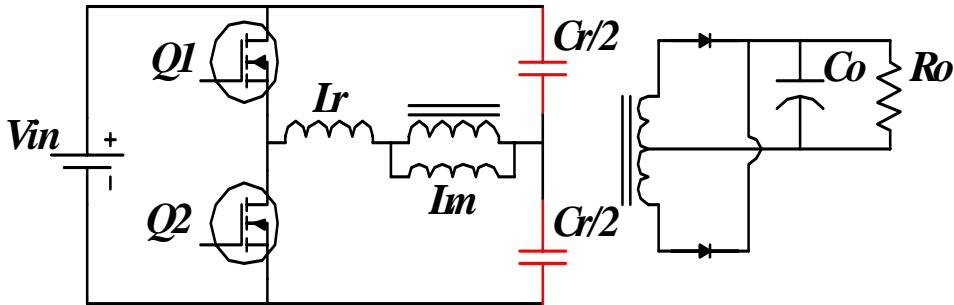
49% and 51%



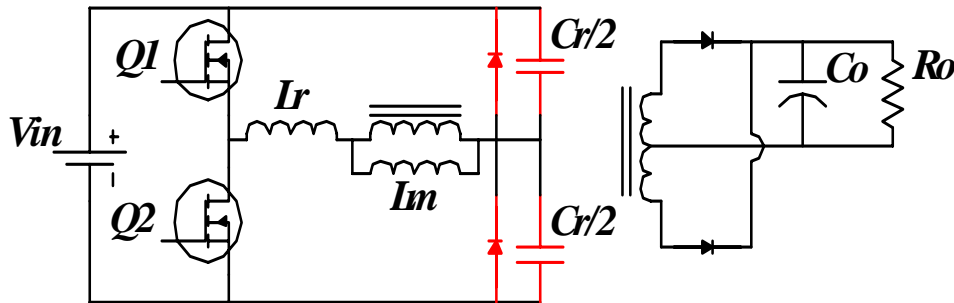
50% and 50%

- Asymmetrical duty cycle makes resonant tank current unbalanced
- Load current will be concentrated in one diode and increase conduction loss and switching loss
- Controller should provide well matched PWM signal
- Different secondary leakage inductance

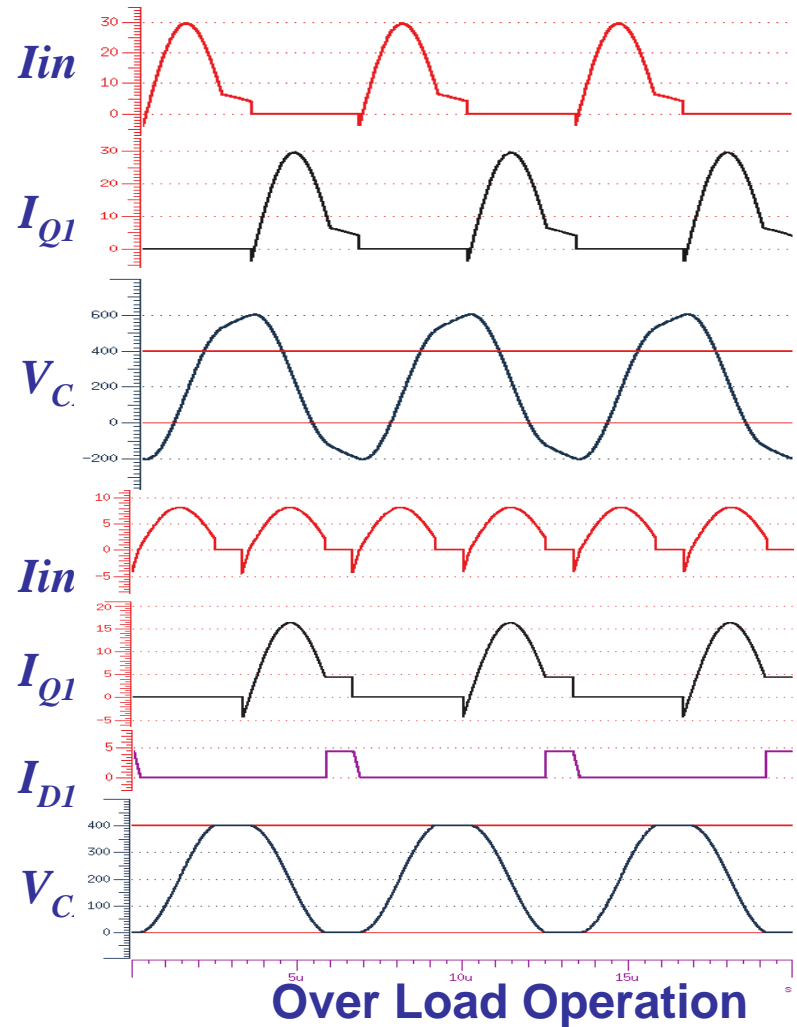
# LLC Issue-Over Current



*Add Clamping Diode*

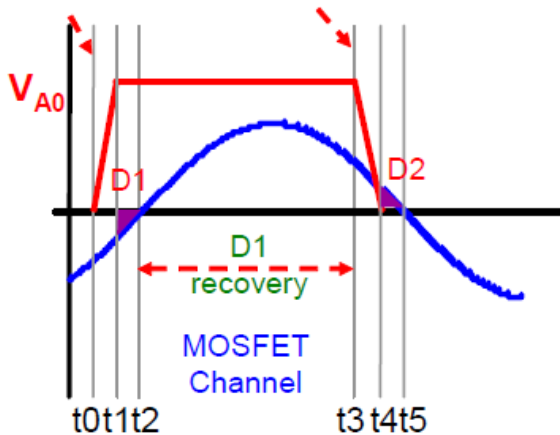
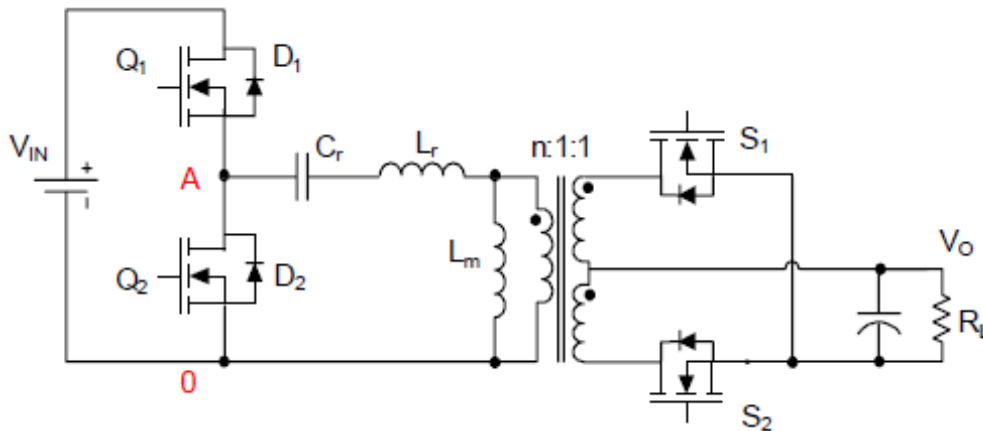


- Part of resonant tank energy could be feedback to source, which helps limit output current





# LLC Issue-MOSFET Failure @ Light Load



To achieve ZVS operation, the body diode of primary MOSFETs conducts first, and then the channel circulates the current.

At light load, the reverse voltage between body diode is much small once the channel circulates the small current, such that the reverse recovery time in body diode is much long, resulting in primary MOSFETs shoot-through.

# References

- Bing Lu, “Investigation of High-density Integrated Solution for AC/DC Conversion of a Distributed Power System”, Ph. D. dissertation, Virginia Tech, 2006  
<http://scholar.lib.vt.edu/theses/available/etd-06262006-111218/>
- Bo Yang, “Topology investigation of front end DC/DC converter for distributed power system “ Ph. D. dissertation, Virginia Tech, 2003  
<http://scholar.lib.vt.edu/theses/available/etd-09152003-180228/>

Back-up

# TI UCC25600

## 8 Pin Resonant Half Bridge Controller

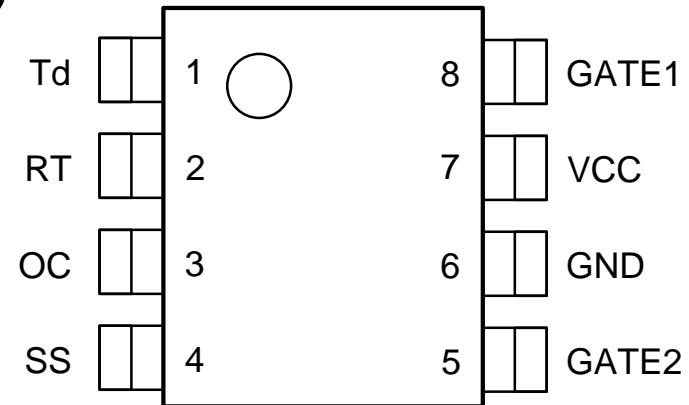
### *Features*

- Adjustable Soft start (1ms to 500ms)
- Adjustable dead time
- Adjustable  $F_{swmax}$  &  $F_{swmin}$  (3% accuracy)
- $I_o = +1A / -1.5A$
- Enable (ON/OFF control)

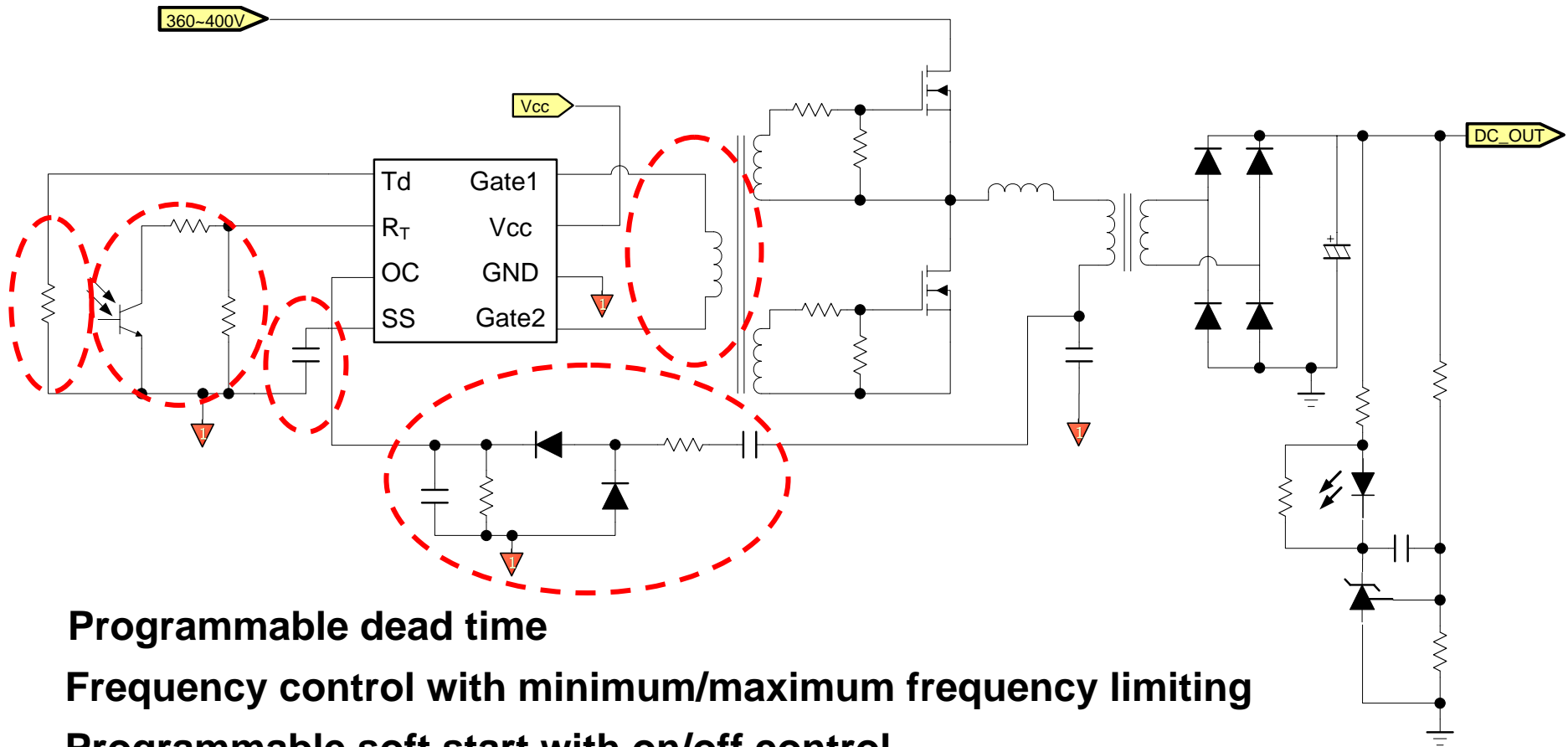
### *Protection functions*

- Two levels over current protection
  - auto recovery
  - latch
- Bias voltage UV and OV protection
- Over temperature protection
- Soft start after all fault conditions

SOT 8 pin package= Easy design and layout



# Application Circuit



**Programmable dead time**

**Frequency control with minimum/maximum frequency limiting**

**Programmable soft start with on/off control**

**Two level over current protection, auto-recovery and latch up**

**Matching output with 50ns tolerance**

Q & A

Thanks!